SEIKO EPSON CORPORATION

CRYSTAL OSCILLATOR (Programmable) **OUTPUT: CMOS**

SG-8018 series

• Frequency range : 0.67 MHz to 170 MHz (1 ppm Step)

 Supply voltage : 1.62 V to 3.63 V

: Output enable (OE) or Standby (ST) Function

• Frequency tolerance : ±50 ppm (-40 °C to +105 °C)

Including frequency aging(+25 °C, 10 years)

• PLL technology to enable short lead time

• Available field oscillator programmer "SG-Writer II"





SG-8018CG: X1G005601xxxx00 SG-8018CE: X1G005591xxxx00 SG-8018CB: X1G005581xxxx00 SG-8018CA: X1G005571xxxx00



CB $7.0 \times 5.0 \text{ mm}$

CG CE $2.5\times2.0~mm\quad 3.2\times2.5~mm$

 $5.0 \times 3.2 \text{ mm}$

Specifications (characteristics)

	lions (chara											
Item Symbol		Specifications				Conditions/Remarks						
Supply voltage		Vcc		V Typ.	2.50 V Typ.	3.30 V Typ.						
			1.62 V to 1.98 V	1.98 V to 2.20 V	2.20 V to 2.80 V	2.70 V to 3.63 V	-					
Output frequency range		f _O	0.67 MHz to 170 MHz									
Storage temper		T_stg			+125 °C		Storage as single product.					
Operating temp		T_use		-40 °C to +105 °C			-					
Frequency tole	rance*1	f_tol	J: ±50 × 10 ⁻⁶			T_use = -40 °C to +105 °C						
Current consumption			3.2 mA Max.	3.3 mA Max.	3.4 mA Max.	3.5 mA Max.	T_use = +105 °C	No load, fo = 20 MHz				
		Icc	2.7 ı	mA Typ.	2.9 mA Typ.	3.0 mA Typ.	T_use = +25 °C	INU IUAU, IO - ZU IVITIZ				
Current consum	приоп	100	5.5 mA Max.	5.8 mA Max.	6.7 mA Max.	8.1 mA Max.	T_use = +105 °C	No load, fo = 170 MHz				
			4.7 1	mA Typ.	5.7 mA Typ.	6.8 mA Typ.	T_use = +25 °C No load, fo = 170 MHz					
Output disable	current	I_dis	3.2 mA Max.	3.2 mA Max.	3.3 mA Max.	3.5 mA Max.	OE = GND, f ₀ = 170 MHz					
Standby curren	ıt	I std	0.9 μA Max.	1.0 µA Max.	1.5 μA Max.	2.5 µA Max.	T_use = +105 °C	ST =	GND			
Standby current		i_stu	0.3 μA Typ.	0.4 μA Typ.	0.5 μA Typ.	1.1 μA Typ.	T_use = +25 °C	51 -	GND			
Symmetry		SYM	45 % to 55 %			50 % V _{CC} Level						
							I _{OH} /I _{OL} Conditions					[mA]
		.,	90 % V _{CC} Min.			Rise/Fall time	V _{CC}	*A	*B	*C	*D	
		Vон				Default (f _O > 40 MHz), Fast			-3.5			
Output voltage							I _{OL}	2.5 -1.5	3.5 -2.0			
(DC characteris	stics)						Default (f _O ≤ 40 MHz)	I _{OL}	1.5	2.0		
`	,						Іон		-1.5			
Outrout load condition		VoL	10 % V _{CC} Max.				I _{OL}	1.0	1.5			
						*A: 1.62 V to 1.98 V, *B: 1.98 V to 2.20 V,						
		L CMOS	15 pF Max.				*C: 2.20 V to 2.80 V, *D: 2.70 V to 3.63 V					
Output load condition							-					
Input voltage		V _{IH}	70 % V _{CC} Min.				OE or ST					
pat remage		VIL	30 % V _{CC} Max.									
Rise time /Fall time	Default		3.0 ns Max.			f ₀ > 40 MHz						
		4/4.6	6.0 ns Max.			f _O ≤ 40 MHz 20 % - 80 % V _{CC}						
	Fast	tr/tf	3.0 ns Max. 10.0 ns Max.			f _O = 0.67 MHz to 170 MHz L_CMOS = 15 pF			•			
	Slow					fo = 0.67 MHz to 20						
Output disable time (OE) Output disable time (ST)		tstp_oe tstp_st	1 μs Max.			Measured from the time OE or ST pin crosses 30 % Vcc						
, , ,		tsta_oe	1 μs Max.			Measured from the time OE pin crosses 70 % Vcc						
Output enable time (ST)		tsta st	3 ms Max.			Measured from the time ST pin crosses 70 % V _{CC}						
Start-up time		t_str	3 ms Max.			Measured from the time V _{CC} reaches its rated minimum value, 1.62 V						
Frequency aging f_age		f_age	This is included in frequency tolerance specification.				+25 °C, 10 years					
. , ,	_		1				1					

^{*1} Frequency tolerance includes initial frequency tolerance, frequency / temperature characteristics, frequency / voltage coefficient, frequency / load coefficient and frequency aging (+25 °C, 10 years).

Pin description

Pin	Name	I/O type	Function	
OE	Input	Output enable	High*2: Specified frequency output from OUT pin	
			Low: Out pin is low (weak pull down), only output driver is disabled.	
1				High*2: Specified frequency output from OUT pin
	ST	Input	Standby	Low: Out pin is low (weak pull down),
			Device goes to standby mode. Supply current reduces to the least as I_std.	
2	GND	Power	Ground	
3	OUT	Output	Clock output	
4	V_{CC}	Power	Power supply	

^{*2} Please do not use the OE/ST terminal in the open state.



Product Name

<u>SG-8018CG</u> <u>25.000000MHz</u> <u>T J H P A</u> <u>4</u>5678

- ①Model ②Package type ③Frequency
- (4) Supply voltage (T: 1.8 V to 3.3 V Typ.)
- ⑤Frequency tolerance (J: ±50 × 10⁻⁶)
- 6 Operating temperature (H: -40 °C to +105 °C)
- 7Function 8Rise/Fall time

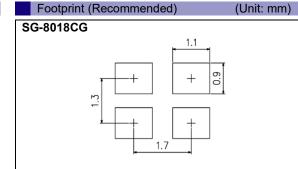
②Package type			
CG	2.5 mm × 2.0 mm		
CE	3.2 mm × 2.5 mm		
СВ	5.0 mm × 3.2 mm		
CA	7.0 mm × 5.0 mm		

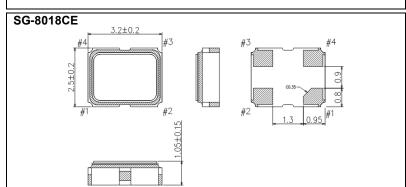
⑦Function				
Р	Output enable			
S	Standby			

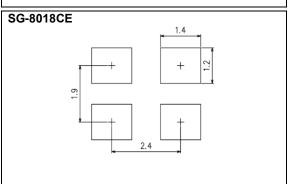
®Rise time/Fall time				
Α	Default			
В	Fast			
C*	Slow			

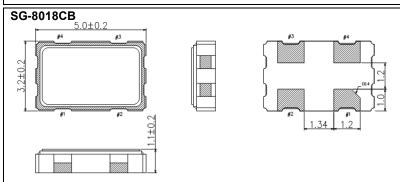
^{*} Available only when fo ≤ 20 MHz

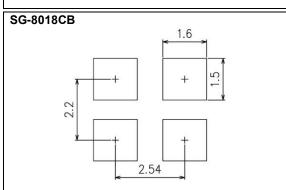
SG-8018CG **A *** A ***

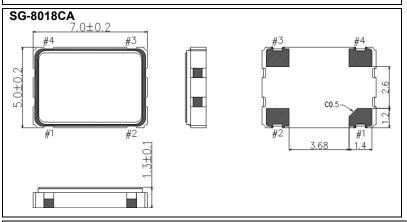


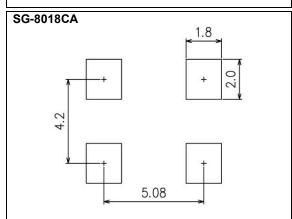












■Notes:

In order to achieve optimum jitter performance, the 0.1 μ F capacitor between V_{CC} and GND should be placed. It is also recommended that the capacitors are placed on the device side of the PCB, as close to the device as possible and connected together with short wiring pattern.

PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

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IATF 16949 is the international standard that added the sector-specific supplemental requirements for automotive industry based on ISO9001.

Explanation of the mark that are using it for the catalog



►Pb free.



► Complies with EU RoHS directive.

*About the products without the Pb-free mark.

Contains Pb in products exempted by EU RoHS directive.

(Contains Pb in sealing glass, high melting temperature type solder or other.)







▶ Designed for automotive applications related to driving safety (Engine Control Unit, Air Bag, ESC etc.).

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